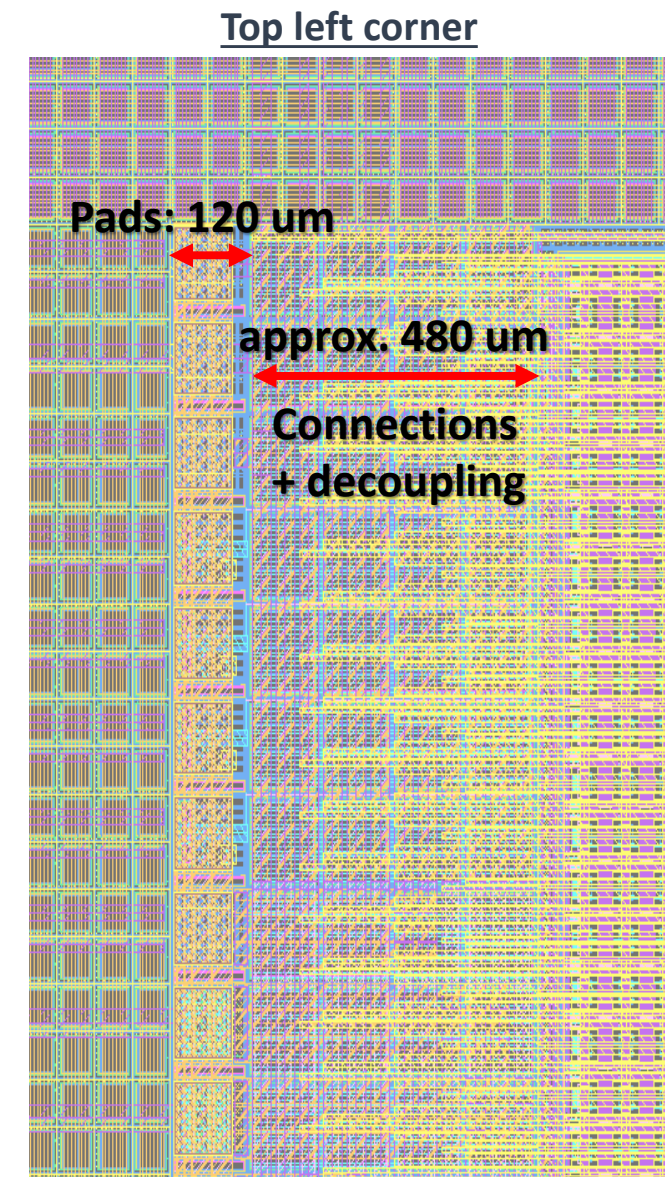
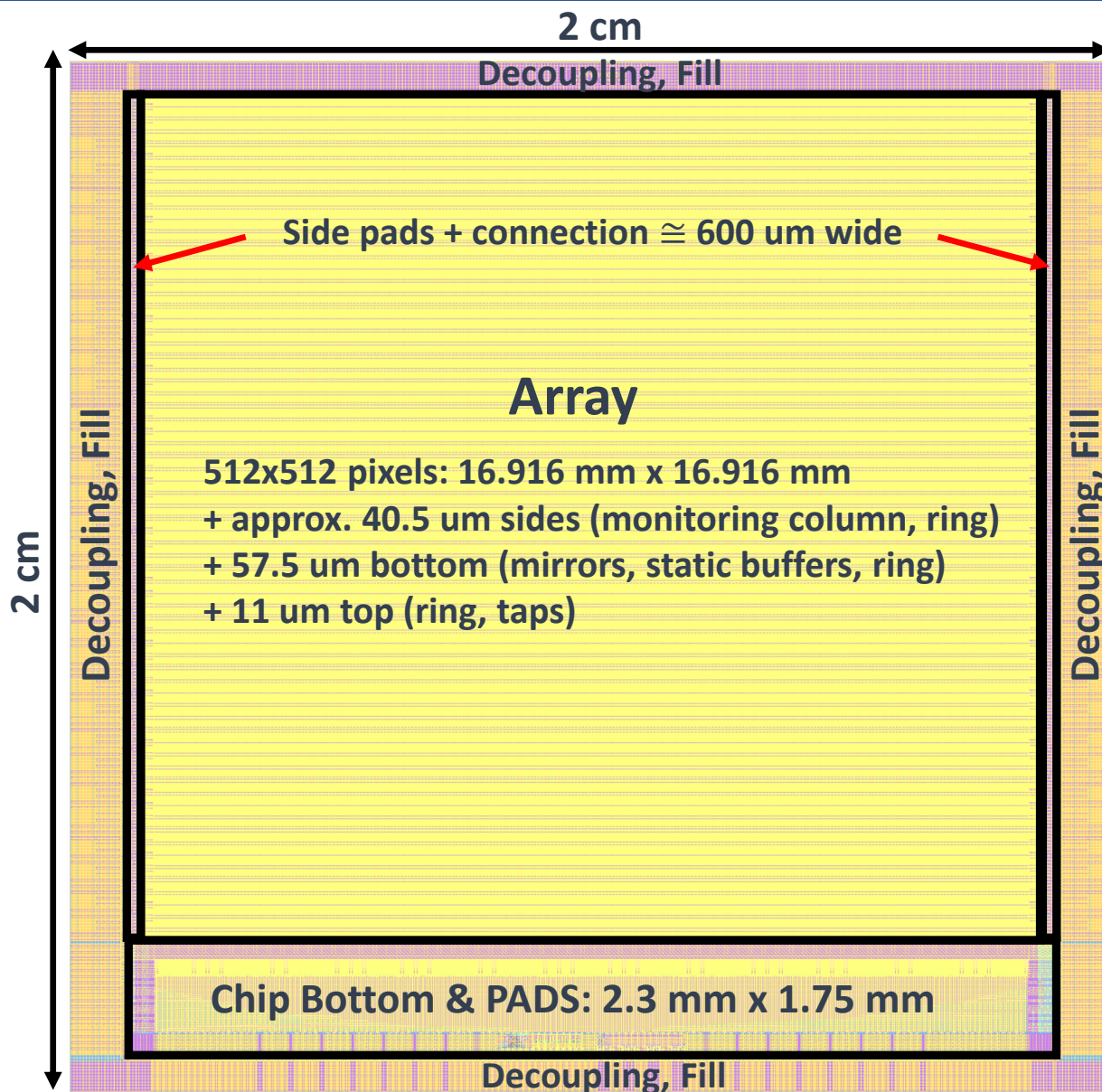
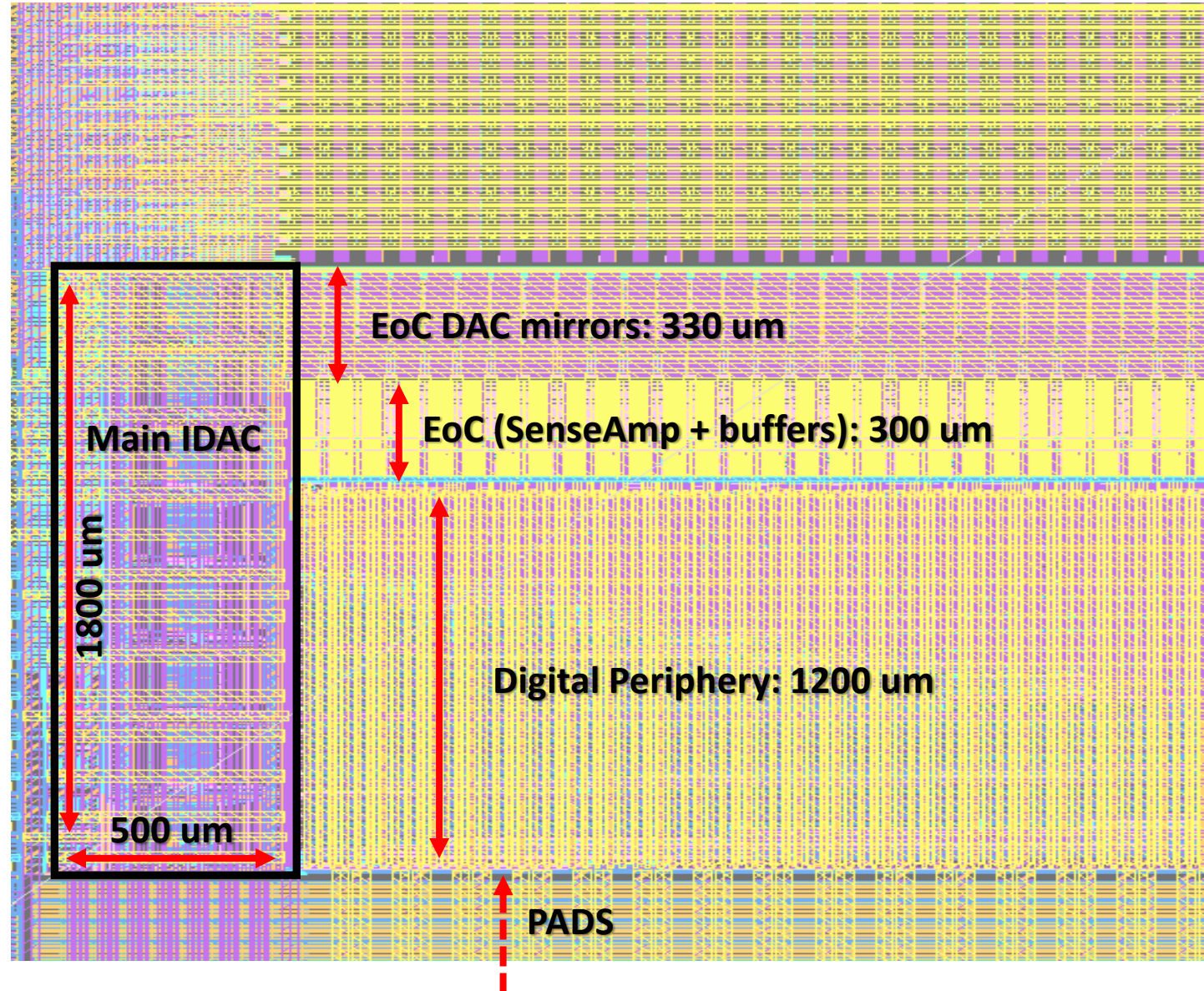


TJ-Monopix2 layout



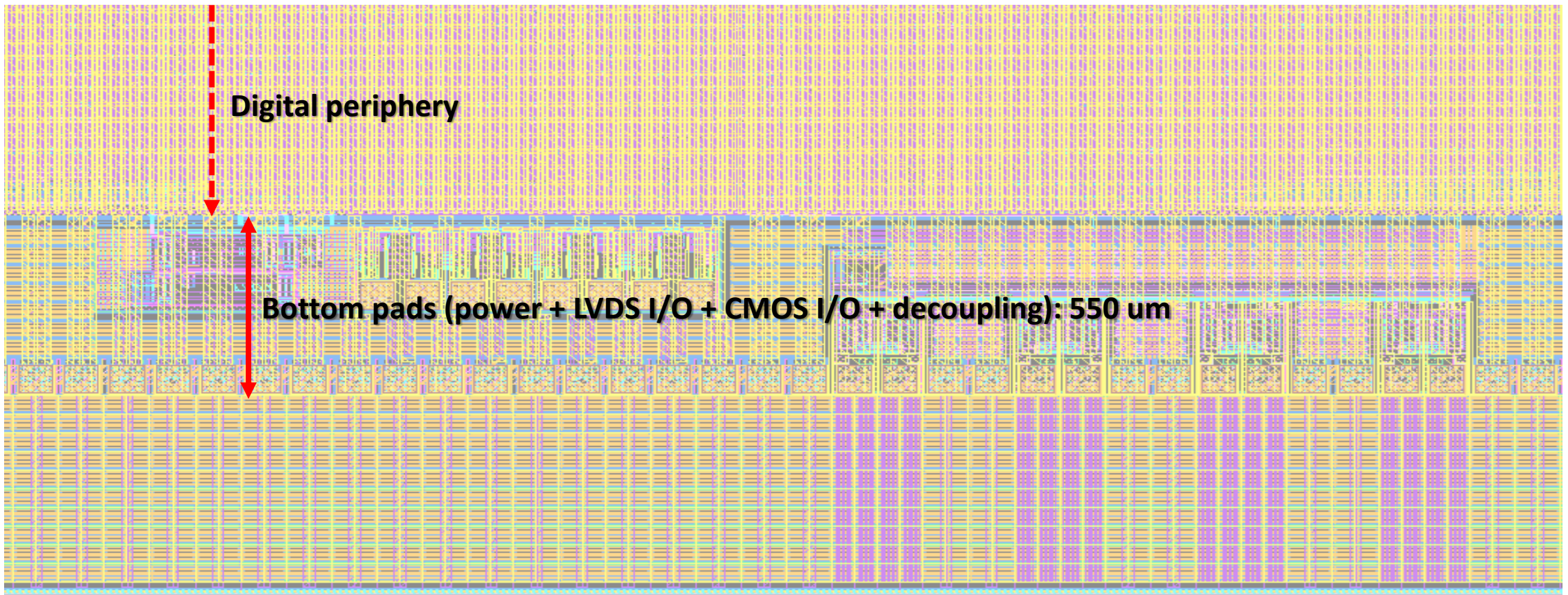
TJ-Monopix2 layout

Bottom left corner



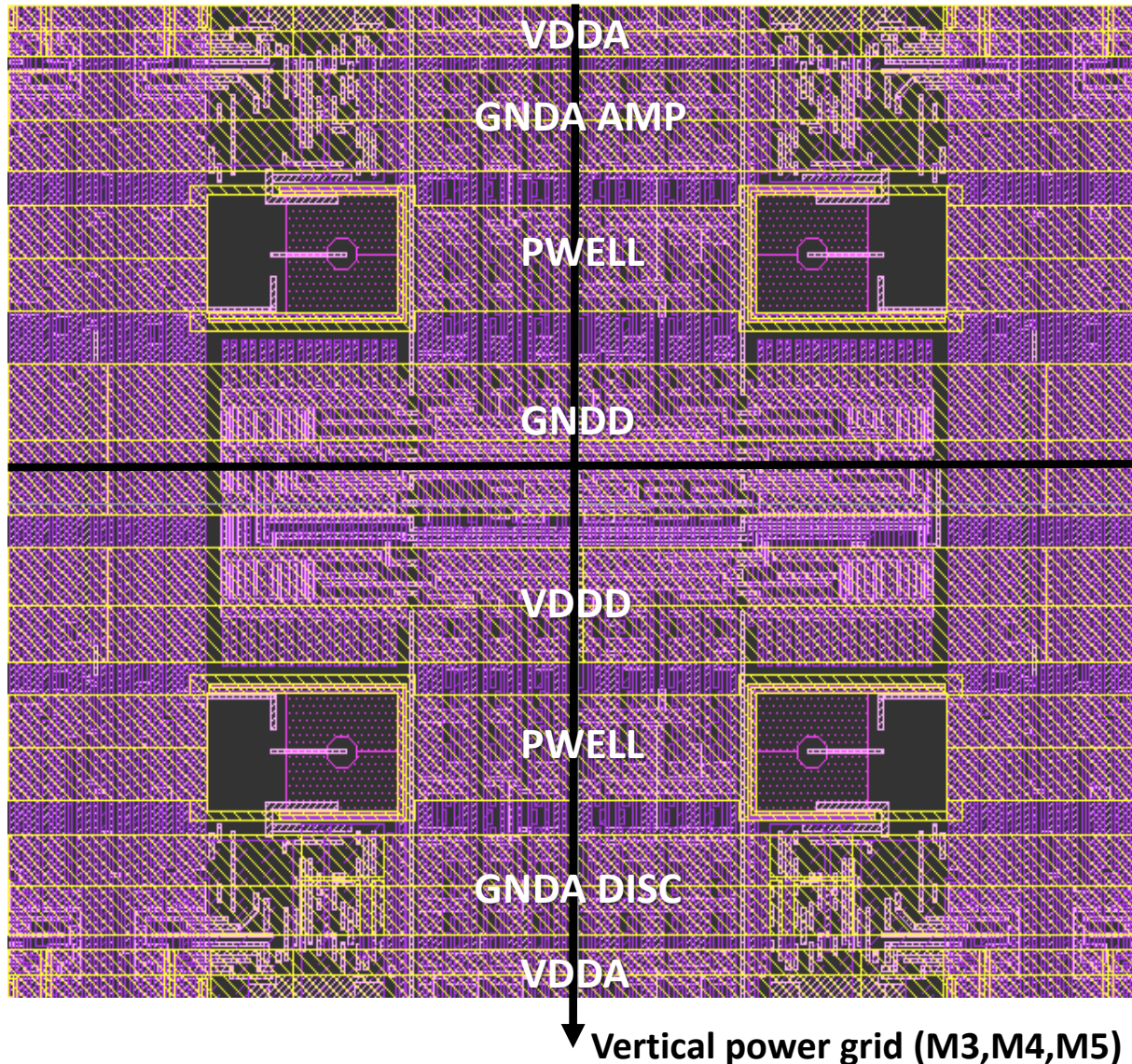
TJ-Monopix2 layout

Bottom PADS



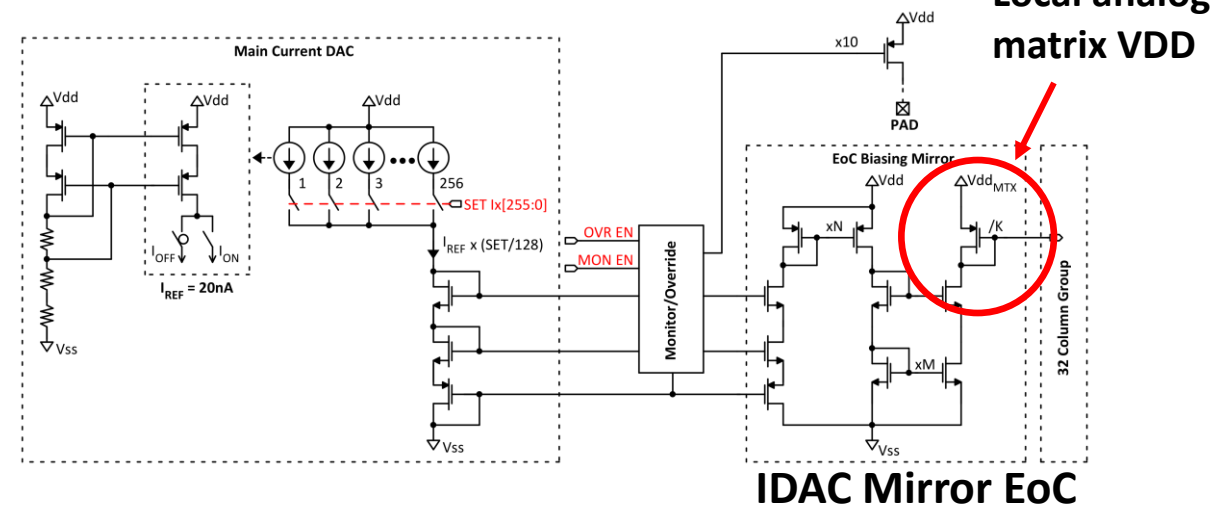
TJ-Monopix2 pixel

2x2 pixel core



- Matrix power pads on both sides
- Horizontal distribution with TOP metal
- Voltage drop compensation (use local VDDA for the final IDAC mirror)
- Challenges for vertical distribution:
 - 5 matrix potentials have to pass through digital periphery + EoC + DAC mirrors (quite limited area + extra cross-coupling)
 - Pixel metal redesign + DAC EoC routing redesign (power also horizontal)
 - No voltage drop compensation (higher threshold dispersion)

Main power distribution
Horizontally, top metal



- **TOP**

- Requires connection from both sides
- Requires redesign of the pixel (powering)
- Systematic threshold spread (ideas...)

- **BOTTOM**

- Requires 7th metal and/or possibly RDL
- Smaller pixel changes
- Extra coupling, other

General:

- We can make pixel bit bigger (now is $\sim 33 \times 33 \mu\text{m}^2$)
- We should use 7th metal

FE is sensitive to voltage drop

